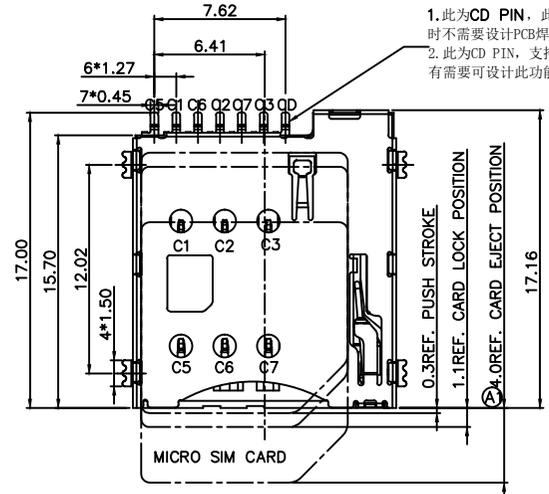
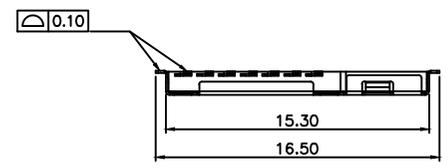
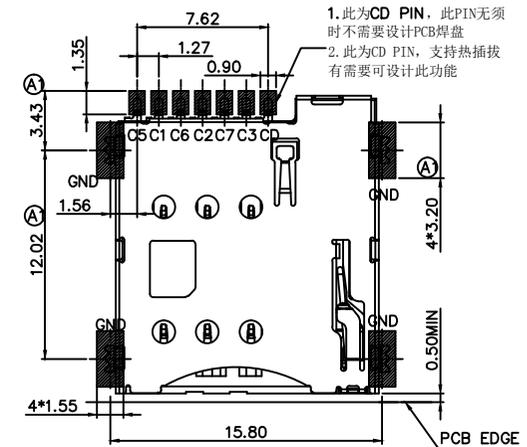
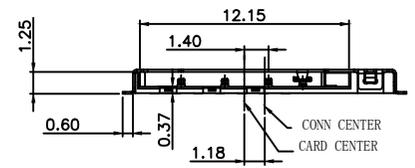
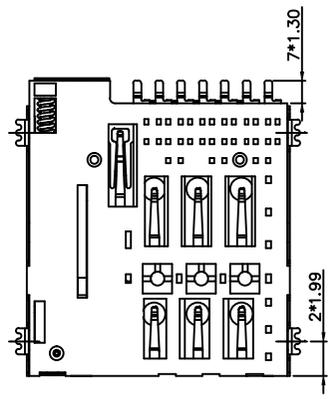
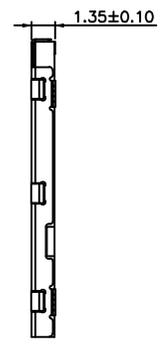


REV	DATE	ECN NO.	MODIFICATION	APPROVER
A	2016/10/14		NEW	Jason_Lee
A1	2017/05/15	RD00317051501	SIZE CHANGE	Jason_Lee

NOTES:
MATERIAL:
Housing: High Temperature thermoplastic, UL94V-0
Terminal: Copper Alloy
Shell: Stainless
SPECIALTY:
Rated Current: 0.5A MAX
Rated Voltage: 50V
Ambient Temperature Range: -40°C~+85°C
Ambient Humidity Range :95% R.H. Max.
Contact Resistance: 100mΩ Max
Insulation Resistance: 1000MΩ/250V DC
Dielectric Withstanding Voltage: 500V AC
Durability: 5000 cycles
Temperature 260±5°C



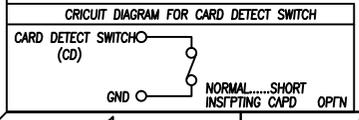
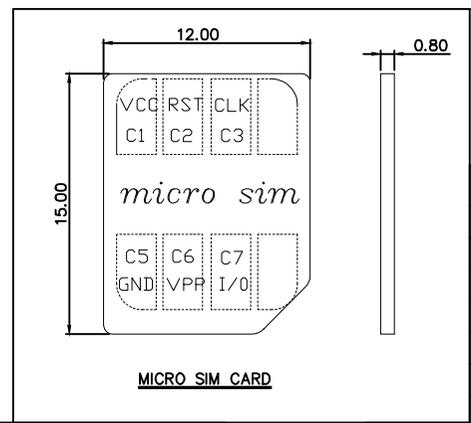
1. 此为CD PIN, 此PIN无须时不需要设计PCB焊盘
2. 此为CD PIN, 支持热插拔有需要可设计此功能



1. 此为CD PIN, 此PIN无须时不需要设计PCB焊盘
2. 此为CD PIN, 支持热插拔有需要可设计此功能

IM pin Assignment	
IN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

■ SMT SOLDER AREA
THERE SHOULD NOT BE ANY CIRCUITRIES IN THE LAYOUT SPACE OF THE PRODUCTS
RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE±0.05



GENERAL TOLERANCE			UNITS mm	NAME: MICRO SIM CARD 6P PUSH PUSH	ATOM 深圳市爱特姆科技有限公司 SHENZHEN ATOM TECHNOLOGY CO., LTD.
SELECT	TOL				
X.XXX	1 2 3	✓	MAT'L	PART NO: SI62C-01200	TITLE: MICRO SIM CARD 6P PUSH PUSH SMT H=1.35mm 带检测脚 无柱
X.XX	±0.10±0.05±0.15			FINISH	APPD:
X.X	±0.15±0.13±0.25		Q'TY		CHKD:
X.	±0.20±0.25±0.5			ANGLE	DR: JACK
	±0.30±0.38±1.00				
	±2°				